



Advance of Cooperative Working in Design, Visualization and Engineering

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Message from the Guest Editors

Recently, many important technologies have emerged or reached a new stage of development, such as cloud computing, machine learning, blockchain, the Internet of Things, big data, and mobile computing. This new computing landscape opens a wider possibility to access social media, e-business, e-learning, e-finance, crowdsourcing, and many other online services. We are excited to see that the scale and popularity have reached a level that our human society has never experienced before. This Special Issue aims to gather original, state-of-the-art research and development contributions on all types of cooperative working applications, but particularly in cooperative design, cooperative visualization, and engineering. This Special Issue will predominantly comprise selected papers of the 19th International Conference on Cooperative Design, Visualization and Engineering (CDVE2022).





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Message from the Editor-in-Chief

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